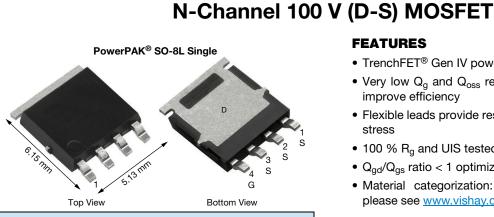
SiJ4108DP

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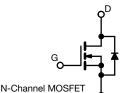
PRODUCT SUMMARY	
V _{DS} (V)	100
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.009
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0106
Q _g typ. (nC)	26.5
I _D (A) ^a	56.7
Configuration	Single

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- Very low Q_g and Q_{oss} reduce power loss and improve efficiency
- · Flexible leads provide resilience to mechanical stress
- 100 % R_q and UIS tested
- Q_{gd}/Q_{gs} ratio < 1 optimizes switching characteristics
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- High power density DC/DC
- DC/AC inverters
- Boost converter
- LED backlighting



ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SiJ4108DP-T1-GE3

ABSOLUTE MAXIMUM RATINGS	$(T_A = 20^{\circ} \text{ O})$, arried		a)	
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V _{DS}	100	v
Gate-source voltage		V _{GS}	± 20	v
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		56.7	
	T _C = 70 °C		45.3	
	T _A = 25 °C	I _D	15.2 ^{b, c}	
	T _A = 70 °C		12.1 ^{b, c}	Α
Pulsed drain current (t = 100 μs)		I _{DM}	150	A
Continuous source-drain diode current	T _C = 25 °C	1	63.1	
	T _A = 25 °C	I _S	4.5 ^{b, c}	
Single pulse avalanche current	ulse avalanche current		25	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	31.25	mJ
Maximum power dissipation	T _C = 25 °C		69.4	
	T _C = 70 °C	D	44	14/
	T _A = 25 °C	PD	5 ^{b, c}	W
	T _A = 70 °C		3.2 ^{b, c}	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	*0
Soldering recommendations (peak temperature) d, e			260	

THEDMAL DESIGTANCE DATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	20	25	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.3	1.8	0/10	

Notes

a. $T_C = 25 \degree C$

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

Maximum under steady state conditions is 65 °C/W f.

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	.		•				
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 1 mA$	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	$I_D = 1 \text{ mA}$	-	63	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-7.3	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zero gate voltage drain current		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 75 °C	-	-	15	μA	
D · · · · · · · ·		V _{GS} = 10 V, I _D = 15 A	-	0.0075	0.009	1	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0085	0.0106	Ω	
Forward transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 15 \text{ A}$	-	70	-	S	
Dynamic ^b	L		<u> </u>				
Input capacitance	Ciss	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	-	2440	-	pF	
Output capacitance	C _{oss}		-	255	-		
Reverse transfer capacitance	C _{rss}		-	16.2	-		
-		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$ $V_{DS} = 50 \text{ V}, V_{GS} = 7.5 \text{ V}, I_D = 15 \text{ A}$	-	34.5	52	nC	
Total gate charge	Qg		-	26.5	40		
Gate-source charge	Q _{qs}		-	12	-		
Gate-drain charge	Q _{gd}		-	5.3	-		
Output charge	Q _{oss}	V _{DS} = 50 V, V _{GS} = 0 V -		46	-	1	
Gate resistance	Rg	f = 1 MHz	0.3	0.8	1.4	Ω	
Turn-on delay time	t _{d(on)}		-	15	30	-	
Rise time	t _r	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = 50 \ \text{V}, \ R_{\text{L}} = 3.33 \ \Omega \\ I_{\text{D}} \cong 15 \ \text{A}, \ V_{\text{GEN}} = 10 \ \text{V}, \ R_{\text{g}} = 1 \ \Omega \end{array}$	-	7	14		
Turn-off delay time	t _{d(off)}		-	25	50		
Fall time	t _f		-	6	12		
Turn-on delay time	t _{d(on)}		-	18	36	ns	
Rise time	t _r	$\begin{array}{l} V_{DD}=50 \text{ V}, \text{ R}_{\text{L}}=3.33 \ \Omega \\ \text{I}_{\text{D}}\cong 15 \text{ A}, \text{ V}_{\text{GEN}}=7.5 \text{ V}, \text{ R}_{\text{g}}=1 \ \Omega \end{array}$	-	8	16	-	
Turn-off delay time	t _{d(off)}		-	22	44		
Fall time	t _f		-	7	14		
Drain-Source Body Diode Characteristic	S					ı	
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	63.1	_	
Pulse diode forward current ($t_p = 100 \ \mu s$)	I _{SM}		-	-	150	A	
Body diode voltage	V _{SD}	I _S = 5 A	-	0.75	1.1	V	
Body diode reverse recovery time	t _{rr}		-	42	84	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, di/dt = 100 A/μs,	-	55	110	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	26	-		
Reverse recovery rise time	t _b		-	16	_	ns	

Notes

a. Pulse test; pulse width $\leq 300~\mu\text{s},$ duty cycle $\leq 2~\%$

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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T_c = -55 °C

6

8

Ciss

Coss

Crss

64

= 7.5 V, 15 A

100 125 150

 V_{GS}

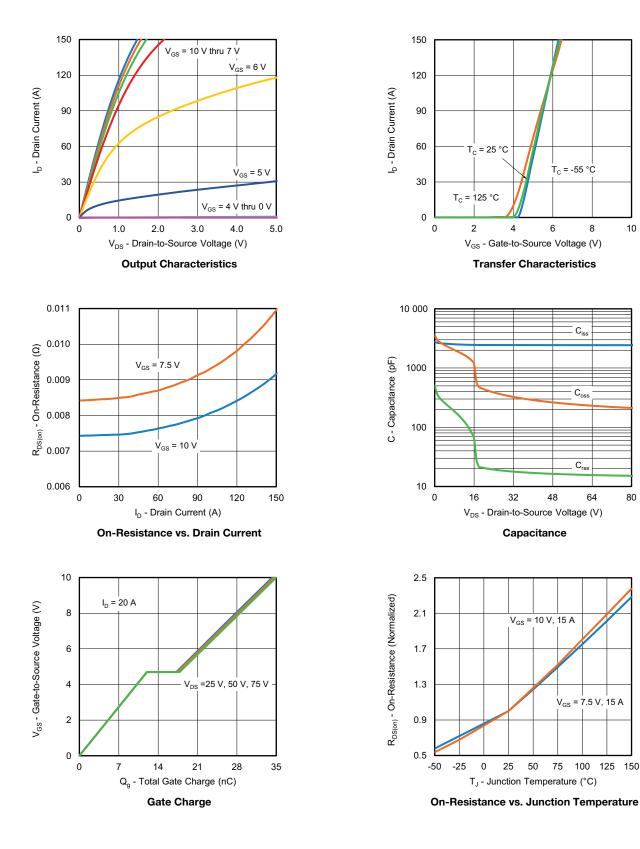
75

48

10

80

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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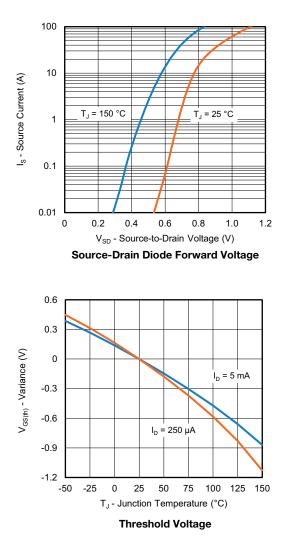
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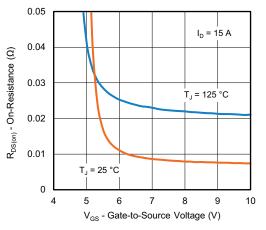
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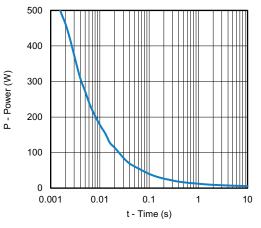
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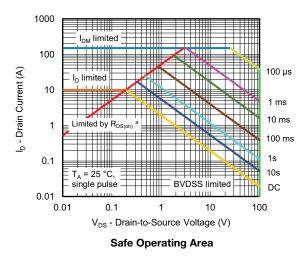




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



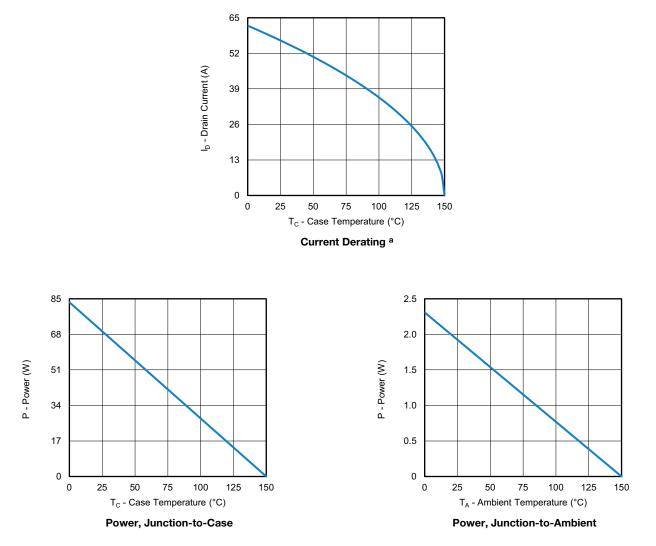
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

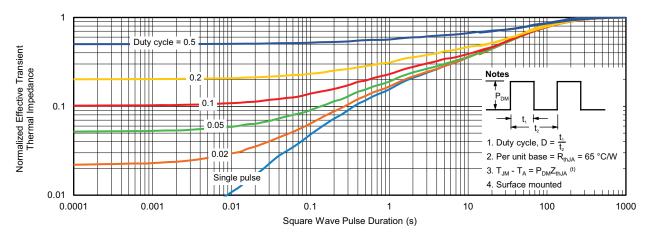
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



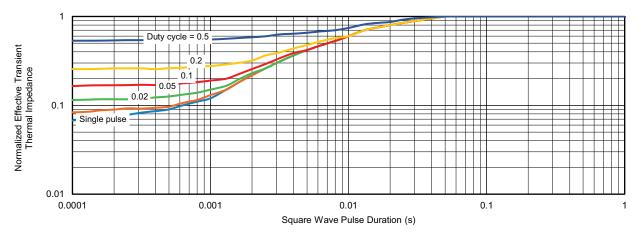
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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